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NANOSECOND PULSER THYRATRONS

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20. Abstract (continued)

cont → ~~has been~~ ^{was} developed. The resistive fall time decreases with rising pressure, but more slowly than predicted by gas breakdown theory, suggesting that it is being limited by the internal design of the thyatron. Fall times of only around 3 ns are obtainable before the pressure gets too high, (0.9 torr), for the 50 μs recovery time required for 20 kHz operation. This will necessitate experimentation with ferrites to delay the current rise until the anode fall is over. Electrode design modifications to decrease the fall and recovery times will also be tested. The 6 kv forward holdoff required under Type II conditions has been attained at pressures up to 1.3 torr by use of a fast pulse charging.



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ABBREVIATIONS AND SYMBOLS

C	Load capacitance
C ₀	Storage capacitor capacitance
E _r	Thyratron reservoir voltage
EIO	Extended interaction oscillator
i	Current (instantaneous)
kv	Kilovolts (pulsed)
kV	Kilovolts (DC)
L	Total circuit inductance (including thyratron)
L _c	Total circuit inductance minus thyratron inductance
L ₀	Inductance of storage capacitor
L _T	Thyratron inductance
nF	Nanofarads
nH	Nanohenries
ns	Nanoseconds
p	Gas pressure
pF	Picofarads
ps	Picoseconds
q	Charge on load capacitor
q ₀	Charge on storage capacitor
R	Thyratron resistance
t	Time
t _f	Thyratron resistive fall time
t _r	Thyratron recovery time
V	Load voltage
V ₀	Initial storage capacitor voltage
Z ₀	Transmission line impedance
μs	Microseconds
τ	e-folding time of thyratron resistance



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1 FOREWORD

This First Interim Technical Report presents the results of the first six months of a program of research and development conducted under ERADCOM Contract DAAK20-80-C-0282, entitled "Nanosecond Pulser Thyratrons," and covers the period 10 July 1980 to 10 December 1980. Experimental results obtained through 30 December 1980 are also included to ensure that this report is up to date.

The work described herein was performed by EG&G, Inc., Electronic Components Division, 35 Congress Street, Salem, Massachusetts 01970.

2 INTRODUCTION AND SUMMARY

a. Project Goals

The ultimate goal is to develop instant start thyratrons and circuits capable of meeting the two sets of requirements listed below:

	<u>Type I</u>	<u>Type II</u>
Peak Forward Voltage	20 kV	6 kV
Peak Anode Current	400 amps	360 amps
Pulse Rise Time (10-90%)	3.0 ns	1.0 ns
Load Capacitance (50% stray capacitance)	60 pF	60 pF
Burst Time	5-30 min	5-30 min
Off Time	120 min	120 min
Pulse Repetition Rate	20 kHz	20 kHz
Maximum Duty Cycle	6×10^{-4}	2×10^{-4}
Life	1000 cycles	1000 cycles
Jitter	100 ps	100 ps

These requirements immediately pose two difficulties. First, the extremely short current rise times require thyatron operation at high internal pressures inimical to the fast recovery needed for 20 kHz operation. Second, the short current rise times demand very low circuit inductance, requiring close integration of thyatron, storage capacitor, and load.

The goals for the first stage of this project were:

- 1) To construct low inductance thyratrons capable of meeting the current, voltage, and average power requirements, and to measure their switching times, recovery times, and voltage holdoff.
- 2) To construct and test low inductance circuits with simulated loads, first without ferrites to find the limits of "unassisted" thyatron operation, and then, if necessary, with ferrites to decrease the current rise time by delaying it until after the resistive fall.(1)

- 3) To theoretically analyze the test results to determine quantitatively how the current rise time is affected by thyatron inductance and resistive fall time.

Progress made during the first six months of the project is summarized briefly in the remainder of this section, and in detail below.

b. Thyatron Construction and Characterization

The Type II conditions were considered first because the lower voltage and average power requirements allowed smaller, cheaper, and more easily constructed thyatrons and circuit assemblies. The thyatron chosen was an HY-3013; basically an HY-1802 shortened for lower inductance, with an auxiliary grid added so that keep-alive could be employed to increase the current rise rate. The inductance was further reduced by use of annular control grid slots and an annular anode stud (Figure 1). This version of the tube was designated HY-3013L s/n 001. When surrounded by a close-fitting current return, the tube had a theoretical inductance of about 8 nH. The reservoir was filled to twice the normal amount to allow operation at relatively high pressures without overheating the filaments. The reservoir calibration is shown in Figure 2.

The resistive fall time, recovery time, and voltage holdoff were measured as functions of pressure and triggering configuration (magnitude and location of the trigger pulse, DC reverse grid bias, and keep-alive). The most important result is that while record anode fall times were achieved (2 ns), these are not fast enough for 1 ns current rise times, and require too high a pressure for 20 kHz operation (due to recovery failure). Therefore, ferrites will probably be required to delay the current rise until after the resistive fall is completed.

c. Low Inductance Circuit and Simulated Load

The load was simulated by a pure 60 pF capacitance, so that the basic circuit was as diagrammed in Figure 3. R is the time-dependent thyatron resistance, L the total circuit inductance (including the thyatron), and C_0 the fast-discharge storage capacitor (initially pulse-charged to $V_0 = 6$ kv). The objective under Type II conditions is to charge the 60 pF capacitor, C , to voltage $V_0 = 6$ kv in 1 ns or less. If thyatron resistance is neglected,

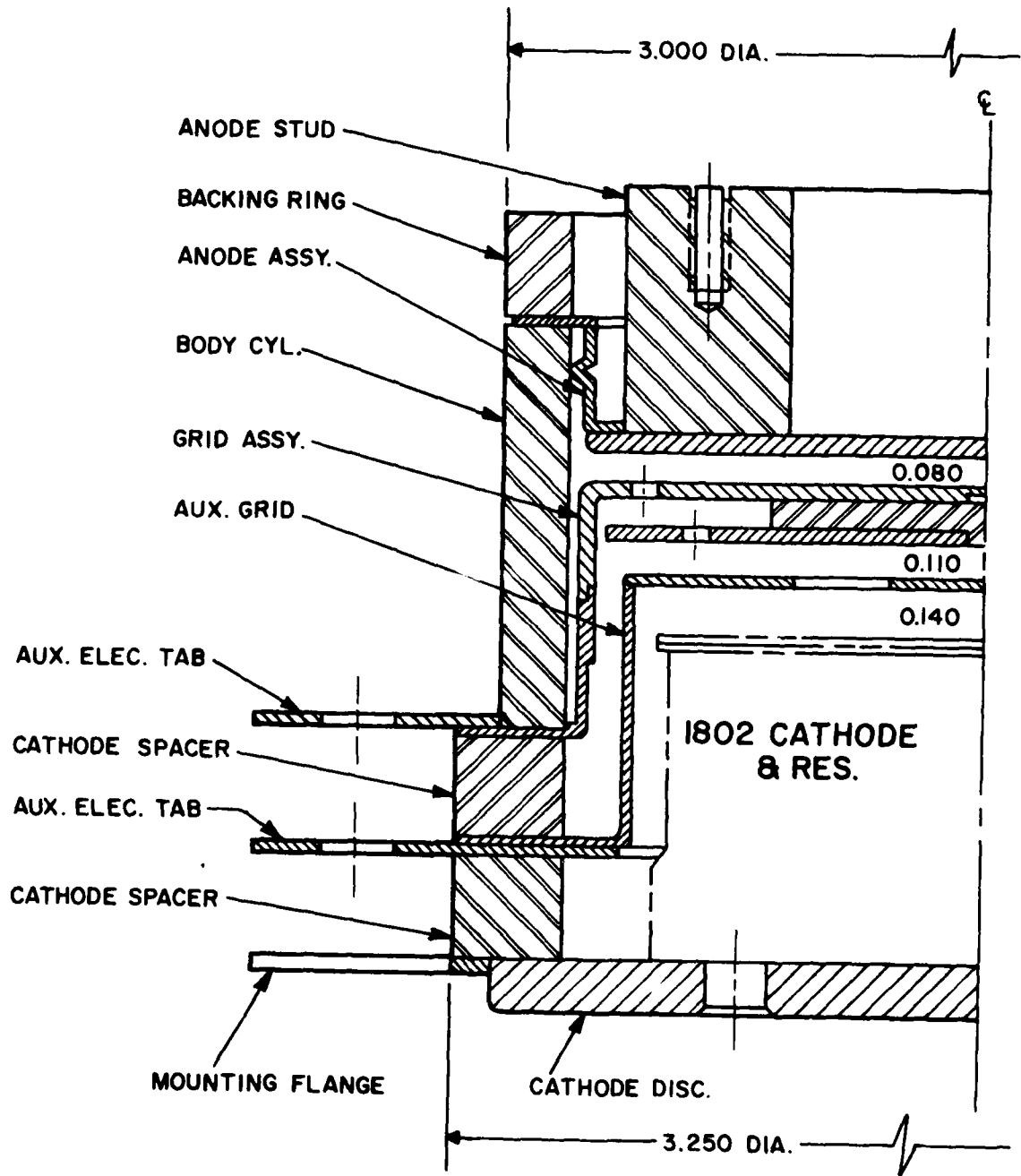


Figure 1. HY-3013L s/n 001 low inductance thyratron.

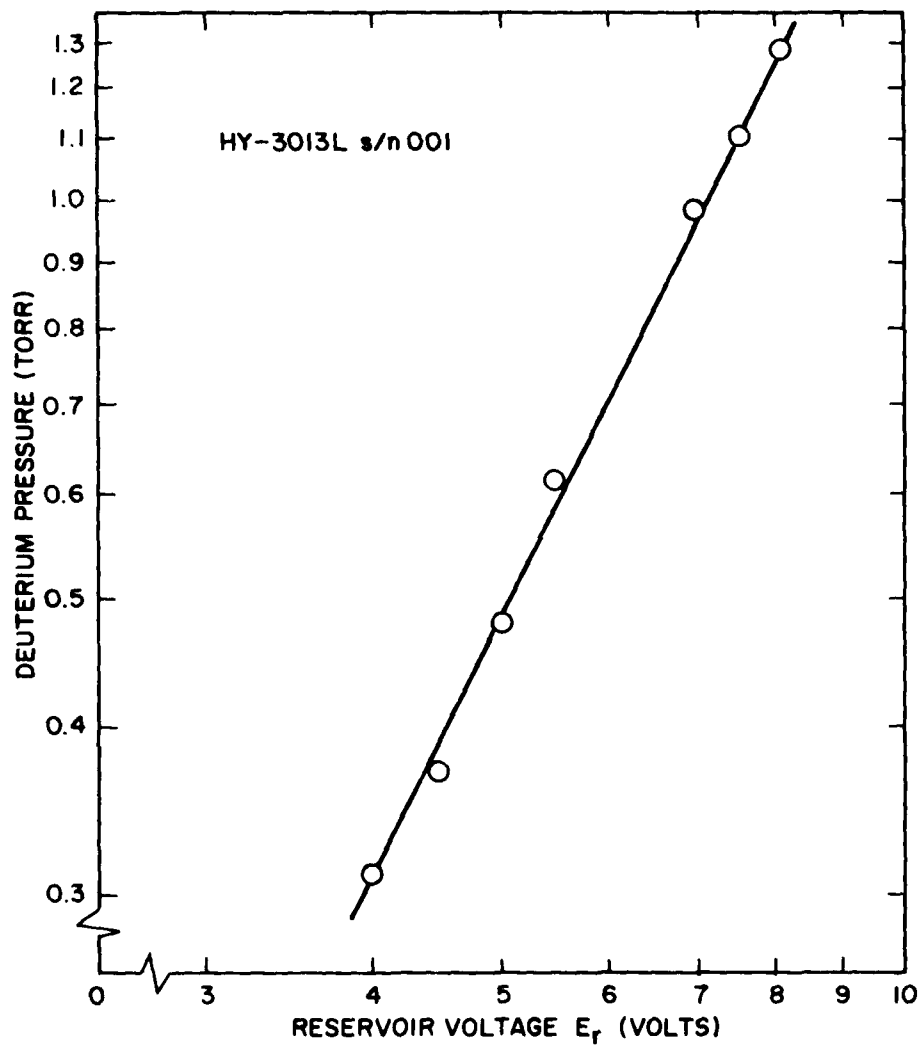


Figure 2. HY-3013L s/n 001 reservoir calibration.

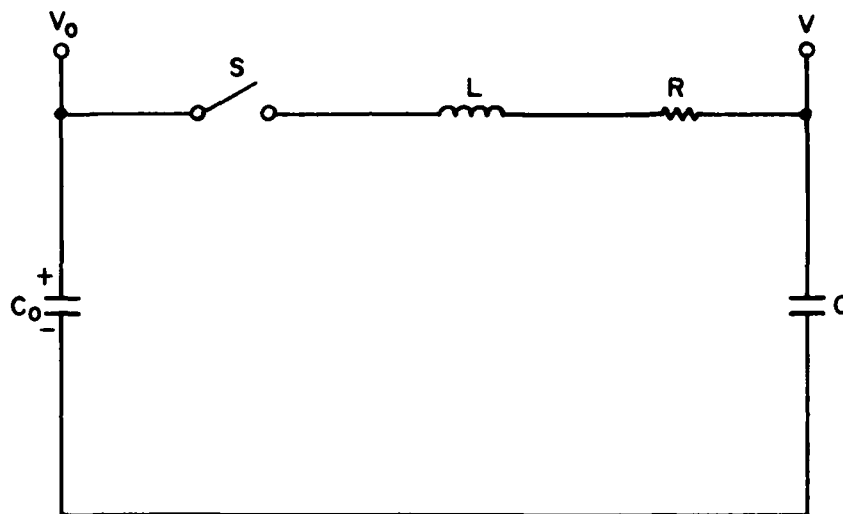


Figure 3. Basic thyatron and load circuit. (S is a perfect switch. Thyatron inductance is included in L. R is the thyatron resistance, which is time dependent. V_0 is the voltage across C_0 before switch S closes. C is the capacitive load.)

then the voltage V across C is given by $V = V_0 (1 - \cos(t/\sqrt{LC}))$, assuming $C \ll C_0$. Therefore, L must be ≤ 7 nH. Allowing C to charge from 10% of V_0 to 90% of V_0 in 1 ns relaxes this requirement to $L \leq 17$ nH. This low value of inductance was achieved as shown in Figure 4a. The ground return is coaxial and has an inside diameter only 0.100 inch larger than the thyatron and storage capacitor. The 60 pF load is an integral part of the structure; no leads are used. To protect against flashover, the entire assembly is immersed in oil. Figure 4b shows the equivalent circuit plus the pulse charging circuit; pulse charging allows 6 kv holdoff to be maintained at pressures up to 1.3 torr. The only diagnostic is a fast high voltage probe of the type developed by Sarjeant and Alcock(2) used in conjunction with a Tektronix 7834 oscilloscope and 7A19 50-ohm plug-in to give an overall diagnostics rise time of 0.9 ns, verified using a 250 ps rise time pulse generator. The probe also serves to discharge the 60 pF load between pulses; its resistance is 3.3 kilohms.

The assembly successfully holds off 6 kv, and the load appears to be charging in a time comparable to the thyatron resistive fall time. Only low repetition rate operation (around 1 Hz) has been attempted.

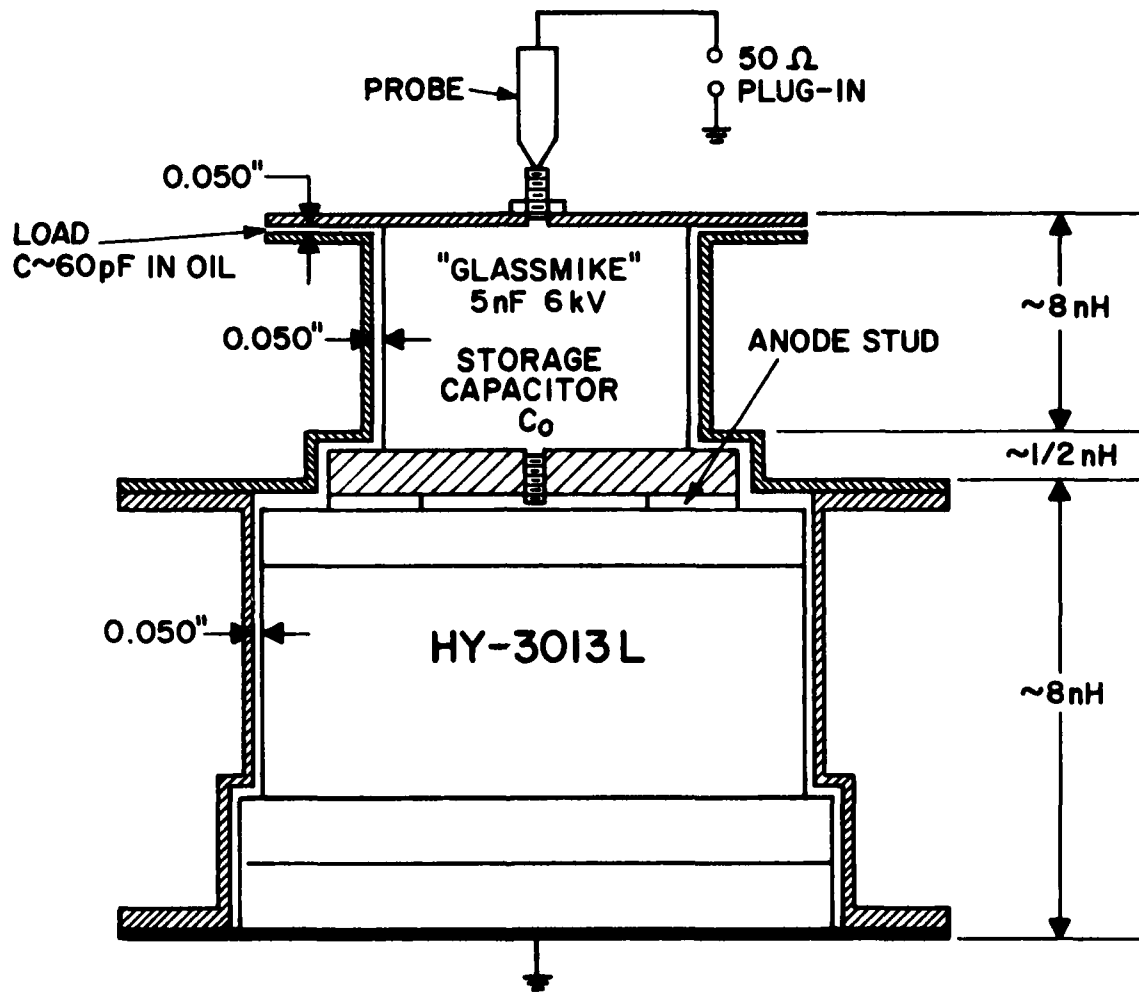


Figure 4a. Low inductance circuit assembly. (Cross-hatched pieces are aluminum. Entire assembly is immersed in oil to avoid flashover. The 5 nF capacitor is charged by a 6 kv pulse applied at the anode stud end.)

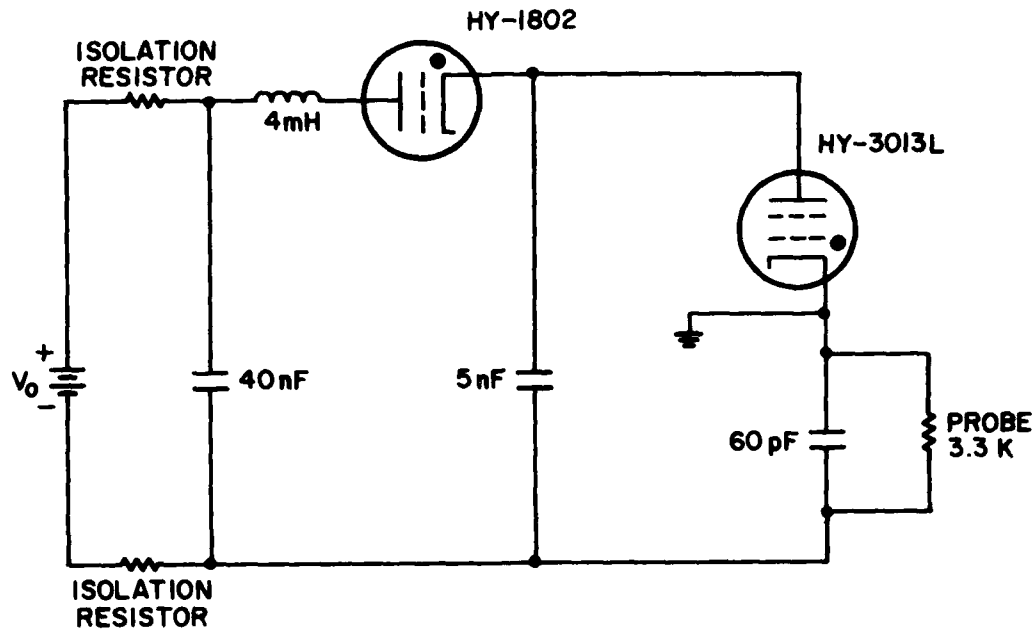


Figure 4b. Equivalent low inductance circuit and pulse charging circuit. (The 40 nF capacitor is charged to 3 kv, which resonantly doubles to 6 kv across the 5 nF capacitor when HY-1802 is triggered. The probe capacitance is much less than 60 pF.)

3 THYRATRON CHARACTERIZATION

a. Resistive Fall Time

Without ferrites to delay the current rise, the thyatron current rise time cannot be shorter than resistive fall time t_f ; hence, the importance of knowing the latter. The circuit and diagnostics used for the measurement are shown in Figure 5. The inductive component of the anode fall was eliminated by making circuit inductance L_C much larger than thyatron inductance L_T , so that $L_T \cdot di/dt \ll V_0$.

The variable to which t_f is most sensitive is pressure, p ; basic gas breakdown theory predicts $t_f \propto 1/p^2$.⁽³⁾ The measured dependence of t_f on p is shown in Figure 6, along with the theoretical curve $t_f = \text{const}/p^2$, normalized to the lowest pressure data point. Clearly, t_f is being limited by factors other than basic gas breakdown, suggesting that changes in internal electrode design could speed the fall time. In particular, larger and/or more numerous grid apertures, and smaller inter-electrode spacings, are being considered. However, these could have the trade-off effect of reducing voltage holdoff.

The triggering techniques used in an attempt to decrease t_f were: use of high trigger voltage (up to 2.5 kv, as compared to the 300 volts actually required for commutation); keep-alive; and reverse control grid bias to delay commutation until the trigger plasma reached maximum density.⁽⁴⁾ These techniques had been found to increase the current rise rate in past experiments^(4,5), but were found here to have no effect on t_f .

b. Recovery Time

A 20 kHz repetition rate requires a thyatron recovery time, t_r , of 50 ns or less. Figure 7 plots the experimental values of t_r vs pressure, along with a plot of resistive fall time, t_f , reproduced from Figure 6. It can be seen that the pressure required to achieve resistive fall times approaching 1 ns is incompatible with 20 kHz operation for the thyatron as presently constructed.

Experiments with larger tubes have shown that recovery time can be reduced by nearly an order of magnitude by employing additional baffles to increase the electrode surface area and hence the plasma loss rate. Reductions in the inter-electrode spacings should also yield a faster plasma loss rate, and hence faster recovery.

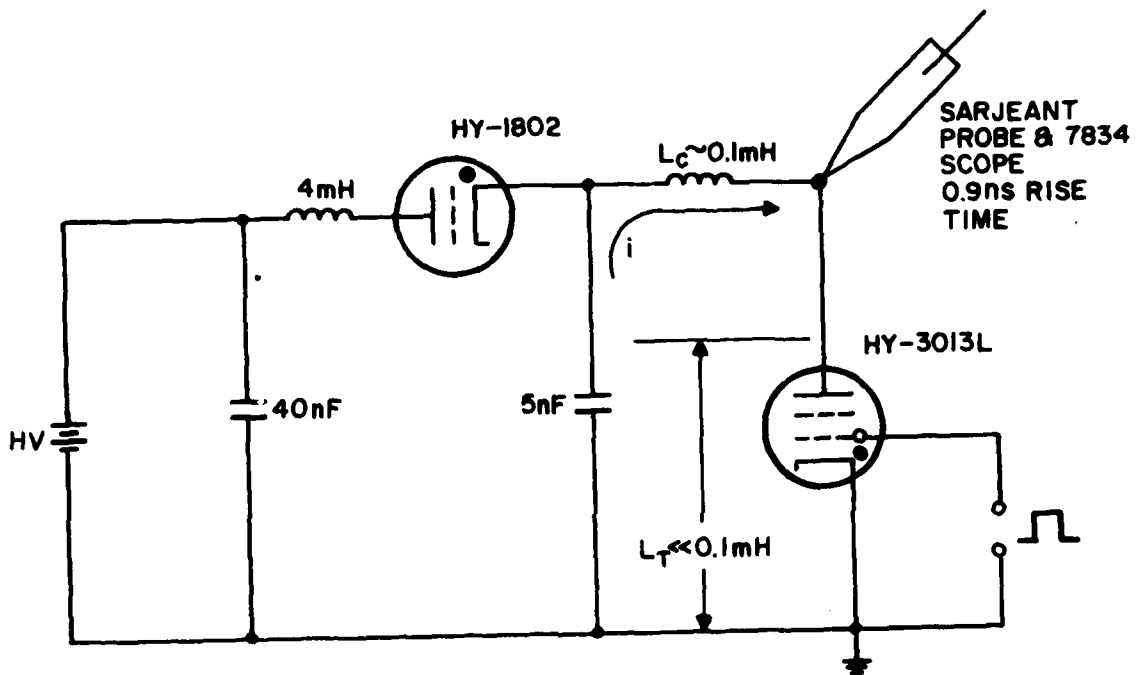


Figure 5. Circuit for measuring resistive fall time.

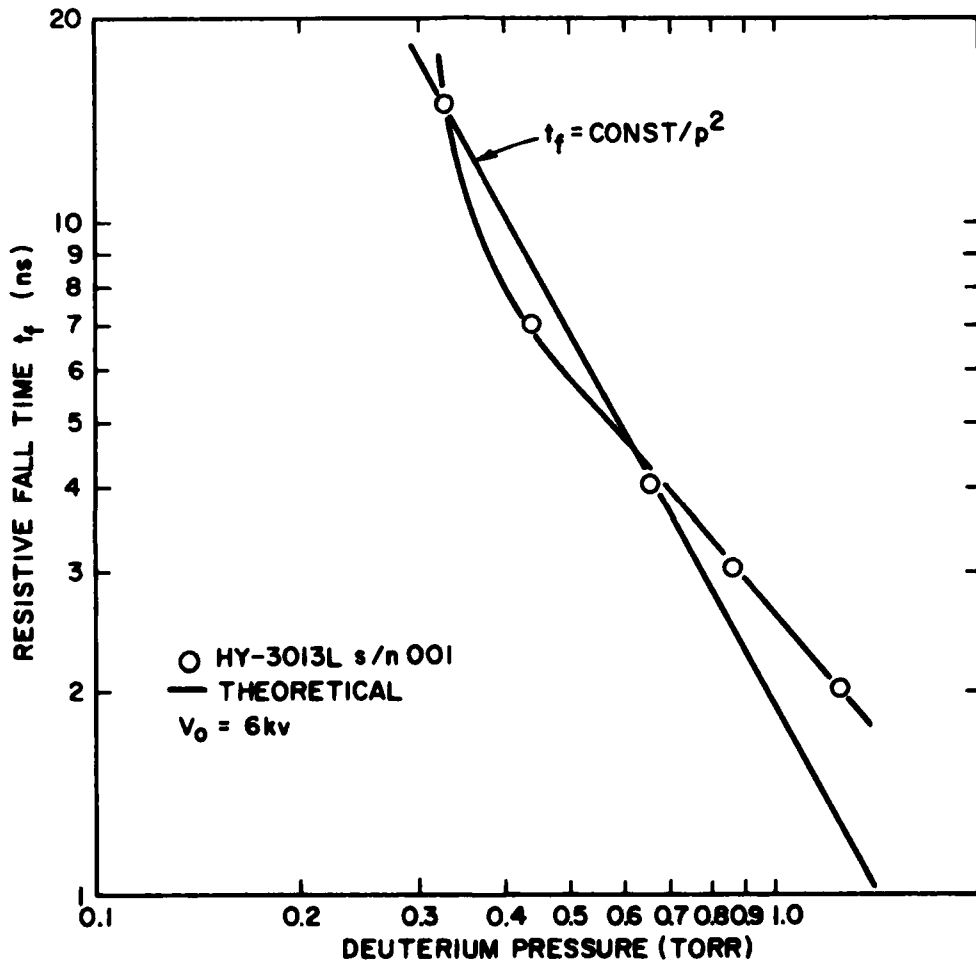


Figure 6. Resistive fall time vs pressure. The theoretical curve is normalized to intersect the experimental curve at the lowest pressure data point. Lower values of t_f could not be obtained because the thyatron failed to hold off 6 kv for pressures above 1.25 torr.

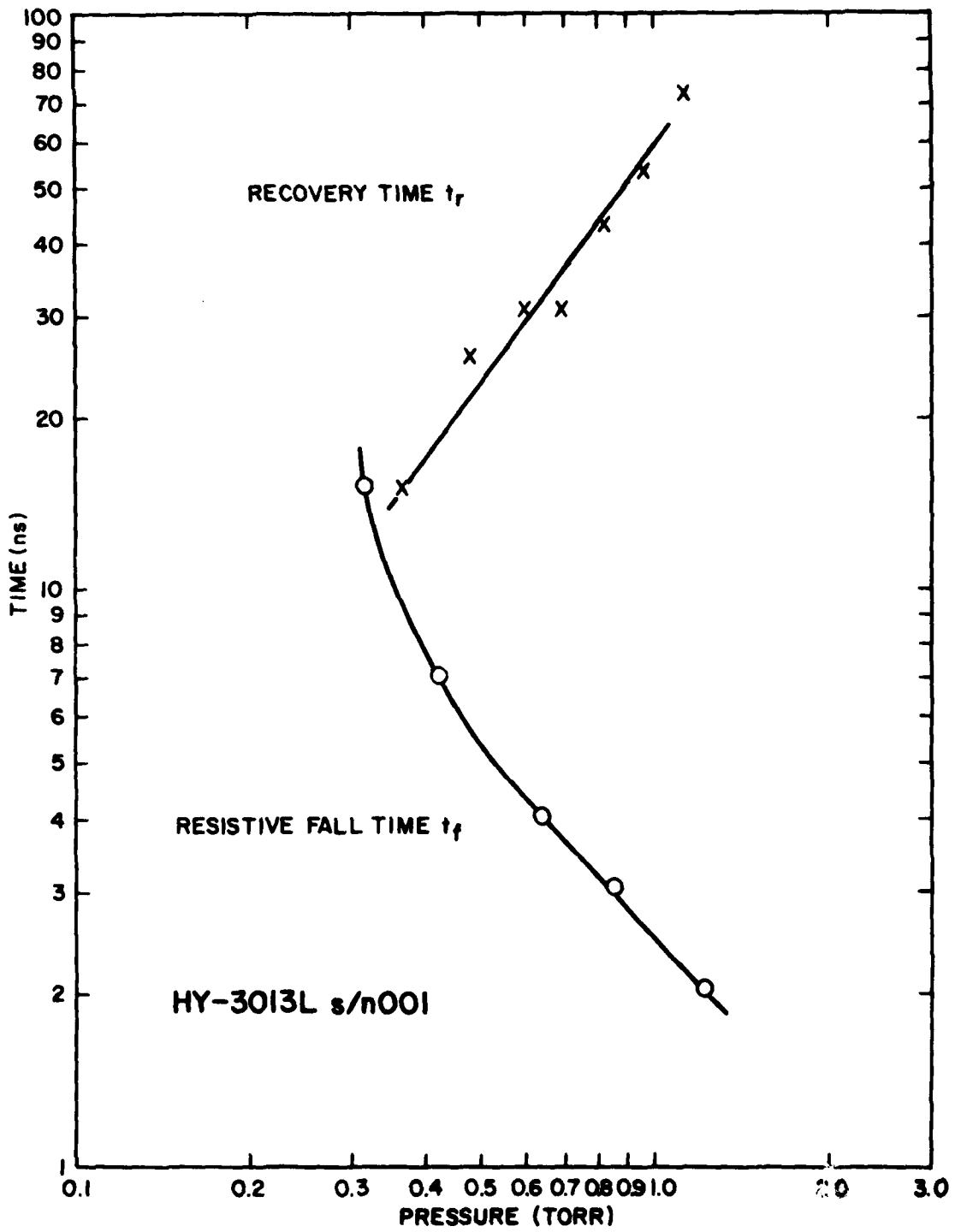


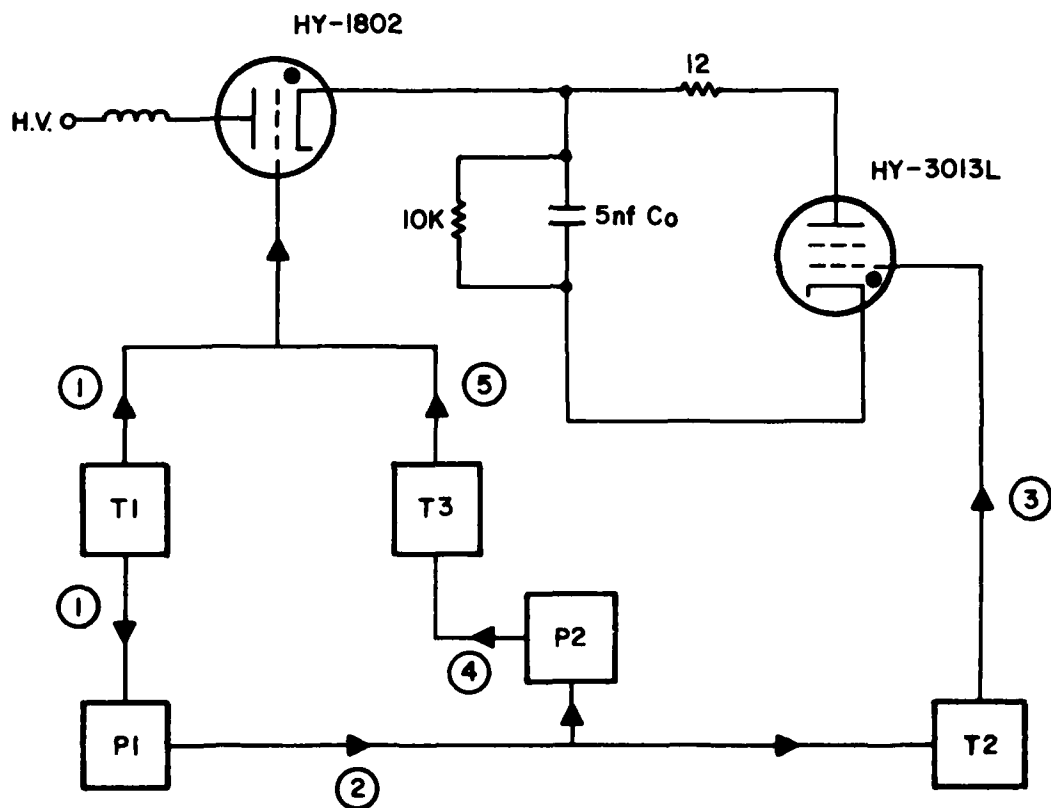
Figure 7. Recovery time vs pressure.

To avoid the power dissipation problems associated with 20 kHz operation, the recovery time measurements were made by firing the thyratron in 2-pulse bursts with, for example, 50 μ s between pulses and 1 second between bursts. Since trigger modules capable of producing two such closely spaced pulses of sufficient amplitude to commutate the HY-1802 and HY-3013L thyratrons were unavailable, the multiple trigger module circuit shown in Figure 8a was used. First, trigger module T1 fired, triggering the HY-1802 and also sending a signal to pulse generator P1. After an adjustable delay of a few μ s, by which time C_0 had charged to 6 kv, P1 sent a pulse to T2, causing it to trigger HY-3013L and thus discharge C_0 through HY-3013L via a 12-ohm resistor, which limited the current to a value comparable to that required under Type II conditions (6 kv x 60 pF/1 ns = 360 amps). P1 simultaneously sent a pulse to P2, which, after an adjustable delay, triggered T3. This again fired the HY-1802, charging C_0 a second time. If HY-3013L had recovered, this second charging pulse would have reached 6 kv and then drained off through the 10 k resistor. If not, HY-3013L lost holdoff and discharged C_0 before 6 kv was reached, as shown in the oscillogram of Figure 8b.

Reverse biasing of the control and auxiliary grids was tried, but failed to affect the recovery time.

c. Forward Voltage Holdoff

To determine how long 6 kv could be held off at various pressures, the charging voltage rise time was reduced to 2.5 μ s (by eliminating the 5 nF capacitor, leaving only the 150 pF capacitance of the HY-3013L itself to be charged), and the Sarjeant probe was replaced by a 100-megohm TEK probe to prevent the charging voltage from decaying significantly during the holdoff time. The tube held off 6 kv DC for reservoir voltages $E_r < 6.0$ V. From 6-8 V, the tube held off for several tens of μ s. At 8 V the holdoff time dropped to less than 1 μ s. This drop was so precipitous that it was not possible within experimental error to meaningfully plot holdoff time vs pressure. For all practical purposes, HY-3013L s/n 001 loses 6 kv holdoff at $E_r = 8.0$ V (about 1.3 torr).



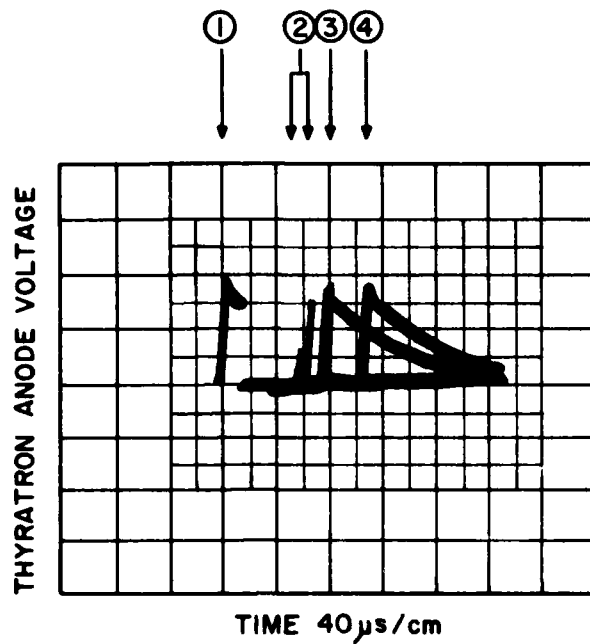
LEGEND:

- ① T1 FIRES HY-1802, CHARGING C₀ AND TRIGGERING PI.
- ② PI TRIGGERS P2 AND T2 AFTER A FEW μs DELAY.
- ③ T2 FIRES HY-3013L, DUMPING C₀.
- ④ AFTER TENS OF μs DELAY, P2 TRIGGERS T3.
- ⑤ T3 FIRES HY-1802, RECHARGING C₀.

NOTE:

ABOUT 1 SECOND LATER, T1 FIRES AGAIN, RESTARTING THE CYCLE.

Figure 8a. Circuit for measuring recovery time.



LEGEND:

- ① INITIAL 6 kv PULSE.
- ② SECOND PULSES ARRIVE BEFORE THYRATRON HAS RECOVERED.
- ③,④ SECOND PULSES WHEN THYRATRON HAS RECOVERED.

NOTE: THE RECOVERY TIME FOR THIS CASE IS 60 μ s

Figure 8b. Typical recovery time data for HY-3013L s/n 001.

d. Conclusions

While modifications of the internal electrode design of HY-3013L s/n 001 may possibly enable the thyatron to simultaneously meet the Type II current rise time, repetition rate, and voltage holdoff requirements, ferrite current delay will probably be required in addition, to allow operation at lower pressures without the current rise rate being limited by the resistive fall time.

4 LOW INDUCTANCE CIRCUIT ANALYSIS

a. Inductance Calculations and Measurements

The low inductance circuit, including storage capacitor, thyatron, and 60 pF load, is shown in Figure 9. The indicated inductance value for the thyatron section is theoretical and assumes an internal current distribution uniform out to the control grid slot diameter. The true current distribution is undoubtedly more complex, given the rapid rise time, but experience has shown that current rise rates calculated on this assumption are in good agreement with the experiments.(4)

The inductance of the 5 nF fast discharge capacitor was determined by measuring its resonant frequency. The circuit designed for this purpose may prove useful in future low inductance design work, and thus is described in detail here.

Inductance L_0 of PFN capacitor C_0 and its current return was found by measuring the resonant frequency using a VHF oscillator. The circuit is shown in Figure 10. Resonance was detected by sensing at what frequency the voltage across the series combination of L_0 and C_0 went through a minimum. To ensure reliable results, the following precautions were taken:

- 1) The length of the circuit was kept to a small fraction of a wavelength. (At 100 MHz, the free space wavelength is 3 meters. The distance from the oscillator to C_0 was about 15 cm.)
- 2) Resistor R was chosen to be \gg 50 ohms, and also to be \gg its stray capacitive and inductive impedances. Thus, the VHF oscillator always sensed a nearly constant impedance. This helped to minimize changes in output voltage with frequency. The small variations that did occur were monitored and corrected by adjusting the oscillator amplitude control.

First, C_0 was measured using a digital capacitance meter and found to be 5.1 nF. The measured resonant frequency was 25 MHz, giving 14 nH inductance. A series of measurements using different lengths of connectors established that 6 nH of this inductance was due to the General Radio "T" connector on which C_0 was mounted, leaving $L_0 \approx 8$ nH.

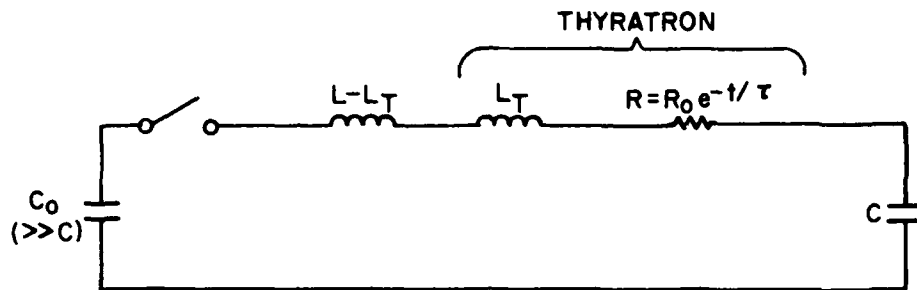


Figure 9. PFN equivalent circuit, including thyatron inductance and resistance.

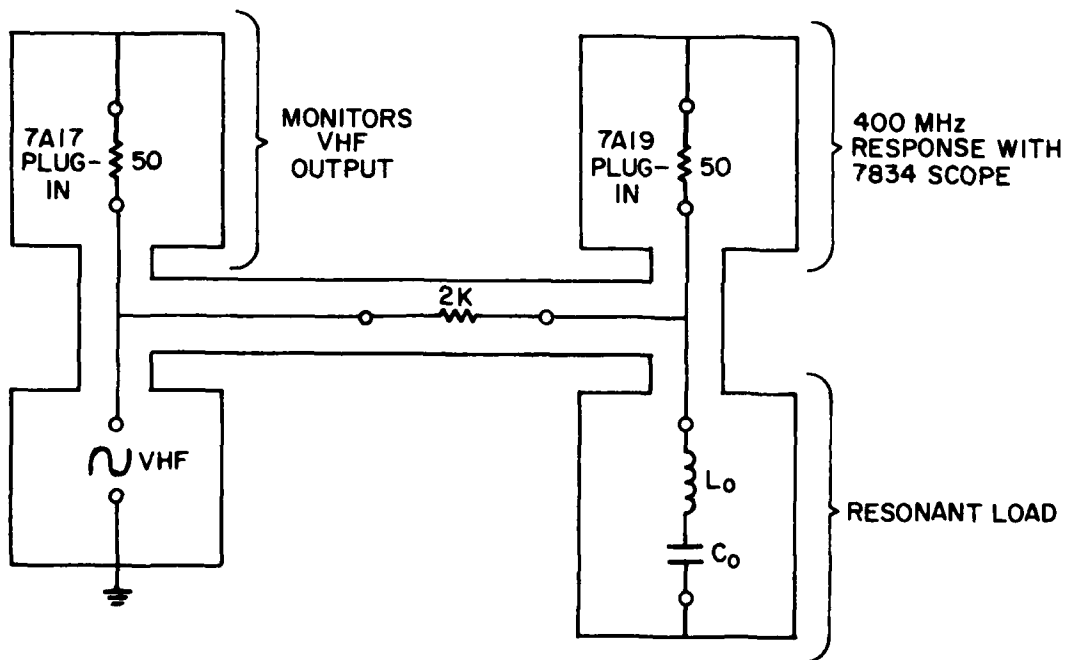


Figure 10. Circuit for measuring nanohenry inductances. General Radio and BNC type connectors used throughout.

This same procedure can be used to measure the inductance of the load, and of future circuit components.

b. Theoretical Analysis of Load Capacitor Charging Time

In the equivalent circuit of Figure 9, L and L_T are the total circuit and thyatron inductances, respectively. R is the thyatron resistance, assumed to decay exponentially with a characteristic decay time, τ , simulating the resistive fall. Initially, PFN capacitor C_0 is charged to voltage V_0 and C is uncharged. Denoting the charges on C_0 and C by q_0 and q , respectively, Kirchoff's equation is

$$\frac{q_0}{C_0} = L \frac{di}{dt} + Ri + \frac{q}{C} \quad (1)$$

From charge conservation,

$$q_0 + q = CV_0, \quad i = \dot{q} = -\dot{q}_0 \quad (2)$$

giving, assuming $C_0 \gg C$,

$$V_0 = L\ddot{q} + R\dot{q} + \frac{q}{C} \quad (3)$$

Load voltage $V = q/C$. Substituting, dividing through by V_0 , and defining $x \equiv V/V_0$ gives

$$\ddot{x} + \frac{R}{L} \dot{x} + \frac{x}{LC} - \frac{1}{LC} = 0 \quad (4)$$

Now substitute $R = R_0 \exp(-t/\tau)$ and define $y \equiv t/\tau$.

$$\frac{d^2x}{dy^2} + \frac{R_0\tau}{L} e^{-y} \frac{dx}{dy} + \left(\frac{\tau}{\sqrt{LC}}\right)^2 x - \left(\frac{\tau}{\sqrt{LC}}\right)^2 = 0 \quad (5)$$

Finally, for R_0 substitute $K \quad L/C$, giving

$$\frac{d^2x}{dy^2} + K \frac{\tau}{\sqrt{LC}} e^{-y} \frac{dx}{dy} + \left(\frac{\tau}{\sqrt{LC}}\right)^2 x - \left(\frac{\tau}{\sqrt{LC}}\right)^2 = 0 \quad (6)$$

This equation has the general form.

$$\frac{d^2x}{dy^2} + f(y) \frac{dx}{dy} + gx - g = 0 \quad (7)$$

where

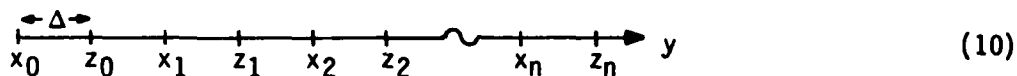
$$g = (\tau/LC)^2 \quad f = K\sqrt{g} e^{-y} \quad (8)$$

In preparation for numerical solution, convert this second order differential equation into two first order equations by introducing a new variable, Z.

$$Z = dx/dy \quad (9)$$

$$\frac{dz}{dy} = -f \frac{dx}{dy} - gx + g$$

Next, divide the y axis into intervals $dy/2 \equiv \Delta$.



The two first order differential equations can now be written as difference equations:

$$x_n = x_{n-1} + z_{n-1} \Delta \quad (11)$$

$$z_n = z_{n-1} + \left(\frac{dz}{dy} \right)_{x=x_n} \Delta$$

resulting in, finally,

$$x_n = x_{n-1} + z_{n-1} \Delta \quad (12)$$

$$z_n = \frac{z_{n-1} - g(x_{n-1})}{1 + f_n \Delta}, \quad f_n = K\sqrt{g} e^{-n\Delta}$$

Equations (10), (11), and (12) are solved in turn, starting with $x_0 = 0$, $y_0 = 0$. (Since Z_0 is actually removed from $y = 0$ by distance Δ , it is not exactly zero. However, the error is negligible if Δ is sufficiently small.)

As Δ gets smaller, the solution gets more accurate but takes longer to compute. $\Delta = 0.1$ is a reasonable compromise.

For the sake of definiteness, τ will be chosen to be 1/4 the total resistive fall time.

Finally, a value must be chosen for K . Recall that $K = R_0/\sqrt{L/C}$ and that R_0 (the thyatron resistance at $t = 0$), is, in principle, infinite. The assumption of a non-infinite value for K is equivalent to beginning the solution at some time $t_1 > 0$, in which case the load voltage waveform for $0 < t < t_1$ is not generated. This is all right, however, because the load voltage rises very slowly near $t = 0$, and only begins its sharp rise later. So long as t_1 comes before this sharp rise, the 10-90% rise time will be accurately depicted. Experience has shown that $K = 1000$ is a good choice.⁽⁴⁾ Larger values prolong the computation without revealing significant additional information.

This simple numerical method can be done in a few minutes on a programmable pocket calculator. Its usefulness and accuracy have been proven elsewhere,⁽⁴⁾ and its appropriateness for this work will be evaluated when appropriate experimental data has been generated.

5 CONCLUSIONS AND FUTURE PLANS

The resistive fall time, recovery time, and forward voltage holdoff of HY-3013L s/n 001 are not far from the Type II requirements. Fulfilling the remaining requirements will require either modifying the internal thyatron structure, using ferrite current delay, or both.

Our plans for the immediate future are to:

- 1) Determine the effect of triggering configuration on the charging time of the 60 pF capacitor in the low inductance circuit. This will include varying the magnitude and location of the trigger pulse, grid bias, and keep-alive.
- 2) Compare low inductance circuit operation with theory.
- 3) Explore the use of ferrites to shorten the current rise time by delaying the current rise until the resistive fall is complete.
- 4) Construct and test HY-3013L type thyatrons with internal modifications designed to speed the resistive fall and to promote faster recovery.

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